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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323hss2008c

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ZGP323H Product Specification



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Absolute Maximum Ratings

Stresses greater than those listed in Table 8 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

Table 7. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	-40	125	° C	1
Storage temperature	-65	+150	° C	
Voltage on any pin with respect to V _{SS}	-0.3	7.0	V	2
Voltage on V_{DD} pin with respect to V_{SS}	-0.3	7.0	V	
Maximum current on input and/or inactive output pin	-5	+5	μA	
Maximum output current from active output pin	-25	+25	mA	
Maximum current into V_{DD} or out of V_{SS}		75	mA	

Notes:

1. See Ordering Information.

2. This voltage applies to all pins except the following: V_{DD}, P32, P33 and RESET.

Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).



Figure 7. Test Load Diagram



AC Characteristics





Figure 8. AC Timing Diagram



Pin Functions

XTAL1 Crystal 1 (Time-Based Input)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator input. Additionally, an optional external single-phase clock can be coded to the on-chip oscillator input.

XTAL2 Crystal 2 (Time-Based Output)

This pin connects a parallel-resonant crystal or ceramic resonant to the on-chip oscillator output.

Port 0 (P07-P00)

Port 0 is an 8-bit, bidirectional, CMOS-compatible port. These eight I/O lines are configured under software control as a nibble I/O port. The output drivers are push-pull or open-drain controlled by bit D2 in the PCON register.

If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 mode register. After a hardware reset, Port 0 is configured as an input port.

An optional pull-up transistor is available as a mask option on all Port 0 bits with nibble select.

Notes: Internal pull-ups are disabled on any given pin or group of port pins when programmed into output mode.

The Port 0 direction is reset to its default state following an SMR.



The counter/timers are mapped into ERF group D. Access is easily performed using the following:

LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	R0,#xx	;	load CTR0
LD	1, #xx	;	load CTR1
LD	R1, 2	;	CTR2→CTR1
LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	RP, #7Dh	;	Select
expanded register bank	D and working	;	register
group 7 of bank 0 for a	ccess.		
LD	71h, 2		
; CTRL2 \rightarrow register 71h			
LD	R1, 2		
; CTRL2 \rightarrow register 71h			

Register File

>

The register file (bank 0) consists of 4 I/O port registers, 237 general-purpose registers, 16 control and status registers (R0–R3, R4–R239, and R240–R255, respectively), and two expanded registers groups in Banks D (see Table 15) and F. Instructions can access registers directly or indirectly through an 8-bit address field, thereby allowing a short, 4-bit register address to use the Register Pointer (Figure 17). In the 4-bit mode, the register file is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer addresses the starting location of the active working register group.





In Demodulation Mode, when set to 0, T16 captures and reloads on detection of all the edges. When set to 1, T16 captures and detects on the first edge but ignores the subsequent edges. For details, see the description of T16 Demodulation Mode on page 47.

Time_Out

This bit is set when T16 times out (terminal count reached). To reset the bit, write a 1 to this location.

T16_Clock

This bit defines the frequency of the input signal to Counter/Timer16.

Capture_INT_Mask

This bit is set to allow an interrupt when data is captured into LO16 and HI16.

Counter_INT_Mask

Set this bit to allow an interrupt when T16 times out.

P35_Out

This bit defines whether P35 is used as a normal output pin or T16 output.

CTR3 T8/T16 Control Register—CTR3(D)03H

Table 18 lists and briefly describes the fields for this register. This register allows the T_8 and T_{16} counters to be synchronized.

Field	Bit Position		Value	Description
T ₁₆ Enable	7	R	0*	Counter Disabled
		R	1	Counter Enabled
		W	0	Stop Counter
		W	1	Enable Counter
T ₈ Enable	-6	R	0*	Counter Disabled
-		R	1	Counter Enabled
		W	0	Stop Counter
		W	1	Enable Counter
Sync Mode	5	R/W	0**	Disable Sync Mode
			1	Enable Sync Mode

Table 18. CTR3 (D)03H: T8/T16 Control Register



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T16 Transmit Mode

In NORMAL or PING-PONG mode, the output of T16 when not enabled, is dependent on CTR1, D0. If it is a 0, T16_OUT is a 1; if it is a 1, T16_OUT is 0. You can force the output of T16 to either a 0 or 1 whether it is enabled or not by programming CTR1 D3; D2 to a 10 or 11.

When T16 is enabled, TC16H * 256 + TC16L is loaded, and T16_OUT is switched to its initial value (CTR1, D0). When T16 counts down to 0, T16_OUT is toggled (in NORMAL or PING-PONG mode), an interrupt (CTR2, D1) is generated (if enabled), and a status bit (CTR2, D5) is set. See Figure 25.



Figure 25. 16-Bit Counter/Timer Circuits

Note: Global interrupts override this function as described in "Interrupts" on page 50.

If T16 is in SINGLE-PASS mode, it is stopped at this point (see Figure 26). If it is in Modulo-N Mode, it is loaded with TC16H * 256 + TC16L, and the counting continues (see Figure 27).

You can modify the values in TC16H and TC16L at any time. The new values take effect when they are loaded.





Figure 30. Interrupt Block Diagram







Figure 34. SCLK Circuit

Stop-Mode Recovery Source (D2, D3, and D4)

These three bits of the SMR specify the wake-up source of the Stop recovery (Figure 35 and Table 22).

Stop-Mode Recovery Register 2—SMR2(F)0DH

Table 21 lists and briefly describes the fields for this register.

Field	Bit Position		Value	Description
Reserved	7		0	Reserved (Must be 0)
Recovery Level	-6	W	0 [†]	Low
-			1	High
Reserved	5		0	Reserved (Must be 0)
Source	432	W	000†	A. POR Only
			001	B. NAND of P23–P20
			010	C. NAND of P27–P20
			011	D. NOR of P33–P31
			100	E. NAND of P33–P31
			101	F. NOR of P33–P31, P00, P07
			110	G. NAND of P33–P31, P00, P07
			111	H. NAND of P33–P31, P22–P20
Reserved	10		00	Reserved (Must be 0)

Table 21. SMR2(F)0DH:Stop	Mode Recovery	Register	2*
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Notes:

* Port pins configured as outputs are ignored as a SMR recovery source. † Indicates the value upon Power-On Reset







Figure 35. Stop Mode Recovery Source



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Watch-Dog Timer Mode Register (WDTMR)

The Watch-Dog Timer (WDT) is a retriggerable one-shot timer that resets the Z8[®] CPU if it reaches its terminal count. The WDT must initially be enabled by executing the WDT instruction. On subsequent executions of the WDT instruction, the WDT is refreshed. The WDT circuit is driven by an on-board RC-oscillator. The WDT instruction affects the Zero (Z), Sign (S), and Overflow (V) flags.

The POR clock source the internal RC-oscillator. Bits 0 and 1 of the WDT register control a tap circuit that determines the minimum timeout period. Bit 2 determines whether the WDT is active during HALT, and Bit 3 determines WDT activity during Stop. Bits 4 through 7 are reserved (Figure 37). This register is accessible only during the first 60 processor cycles (120 XTAL clocks) from the execution of the first instruction after Power-On-Reset, Watch-Dog Reset, or a Stop-Mode Recovery (Figure 36). After this point, the register cannot be modified by any means (intentional or otherwise). The WDTMR cannot be read. The register is located in Bank F of the Expanded Register Group at address location 0Fh. It is organized as shown in Figure 37.

WDTMR(0F)0Fh



* Default setting after reset

Figure 37. Watch-Dog Timer Mode Register (Write Only)

WDT Time Select (D0, D1)

This bit selects the WDT time period. It is configured as indicated in Table 23.



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CTR2(0D)02H



Figure 41. T16 Control Register ((0D) 2H: Read/Write Except Where Noted)



SMR(0F)0BH



- * Default setting after reset
- * * Set after Stop Mode Recovery
- * * * At the XOR gate input
- * * * * Default setting after reset. Must be 1 if using a crystal or resonator clock source.
- * * * * * Default setting after Power On Reset. Not reset with a Stop Mode recovery.

Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)





Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset. Not reset with a Stop Mode recovery.

* * At the XOR gate input

Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only)



R247 P3M(F7H)



* Default setting after reset. Not reset with a Stop Mode recovery.

Figure 49. Port 3 Mode Register (F7H: Write Only)



R252 Flags(FCH)



Figure 54. Flag Register (FCH: Read/Write)

R253 RP(FDH)



Default setting after reset = 0000 0000

Figure 55. Register Pointer (FDH: Read/Write)



R254 SPH(FEH)



Figure 56. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)



Stack Pointer Low Byte (SP7–SP0)

Figure 57. Stack Pointer Low (FFH: Read/Write)

Package Information

Package information for all versions of ZGP323H is depicted in Figures 59 through Figure 68.



MILLIMETER

MAX

2.65

0.30

2.44

0.46

0.30

12.95

7.60

10.65

0.40

1.00

1.07

1.27 BSC



INCH

мах

.104

.012

.096

.018

.012

.510

.299

.419

.016

.039

.042

.050 BSC

MIN

.094

.004

.088

.014

.009

.496

.291

.394

.012

.024

.038



Figure 60. 20-Pin SOIC Package Diagram

PS023803-0305

ZGP323H Product Specification



Ordering Information

32KB Standard Temperature: 0° to +70°C

-			
Part Number	Description	Part Number	Description
ZGP323HSH4832C	48-pin SSOP 32K OTP	ZGP323HSS2832C	28-pin SOIC 32K OTP
ZGP323HSP4032C	40-pin PDIP 32K OTP	ZGP323HSH2032C	20-pin SSOP 32K OTP
ZGP323HSK2832E	28-pin CDIP 32K OTP	ZGP323HSK2032E	20-pin CDIP 32K OTP
ZGP323HSK4032E	40-pin CDIP 32K OTP	ZGP323HSP2032C	20-pin PDIP 32K OTP
ZGP323HSH2832C	28-pin SSOP 32K OTP	ZGP323HSS2032C	20-pin SOIC 32K OTP
ZGP323HSP2832C	28-pin PDIP 32K OTP		

32KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323HEH4832C	48-pin SSOP 32K OTP	ZGP323HES2832C	28-pin SOIC 32K OTP
ZGP323HEP4032C	40-pin PDIP 32K OTP	ZGP323HEH2032C	20-pin SSOP 32K OTP
ZGP323HEH2832C	28-pin SSOP 32K OTP	ZGP323HEP2032C	20-pin PDIP 32K OTP
ZGP323HEP2832C	28-pin PDIP 32K OTP	ZGP323HES2032C	20-pin SOIC 32K OTP

32KB Automotive Temperature: -40° to +125°C				
Part Number	Description	Part Number	Description	
ZGP323HAH4832C	48-pin SSOP 32K OTP	ZGP323HAS2832C	28-pin SOIC 32K OTP	
ZGP323HAP4032C	40-pin PDIP 32K OTP	ZGP323HAH2032C	20-pin SSOP 32K OTP	
ZGP323HAH2832C	28-pin SSOP 32K OTP	ZGP323HAP2032C	20-pin PDIP 32K OTP	
ZGP323HAP2832C	28-pin PDIP 32K OTP	ZGP323HAS2032C	20-pin SOIC 32K OTP	
Replace C with G fo	r Lead-Free Packaging			





8KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323HSH4808C	48-pin SSOP 8K OTP	ZGP323HSS2808C	28-pin SOIC 8K OTP
ZGP323HSP4008C	40-pin PDIP 8K OTP	ZGP323HSH2008C	20-pin SSOP 8K OTP
ZGP323HSH2808C	28-pin SSOP 8K OTP	ZGP323HSP2008C	20-pin PDIP 8K OTP
ZGP323HSP2808C	28-pin PDIP 8K OTP	ZGP323HSS2008C	20-pin SOIC 8K OTP

8KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323HEH4808C	48-pin SSOP 8K OTP	ZGP323HES2808C	28-pin SOIC 8K OTP
ZGP323HEP4008C	40-pin PDIP 8K OTP	ZGP323HEH2008C	20-pin SSOP 8K OTP
ZGP323HEH2808C	28-pin SSOP 8K OTP	ZGP323HEP2008C	20-pin PDIP 8K OTP
ZGP323HEP2808C	28-pin PDIP 8K OTP	ZGP323HES2008C	20-pin SOIC 8K OTP

8KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
	Becchption	T alt Hallbol	Beeenpaien
ZGP323HAH4808C	48-pin SSOP 8K OTP	ZGP323HAS2808C	28-pin SOIC 8K OTP
ZGP323HAP4008C	40-pin PDIP 8K OTP	ZGP323HAH2008C	20-pin SSOP 8K OTP
ZGP323HAH2808C	28-pin SSOP 8K OTP	ZGP323HAP2008C	20-pin PDIP 8K OTP
ZGP323HAP2808C	28-pin PDIP 8K OTP	ZGP323HAS2008C	20-pin SOIC 8K OTP
Replace C with G for Lead-Free Packaging			